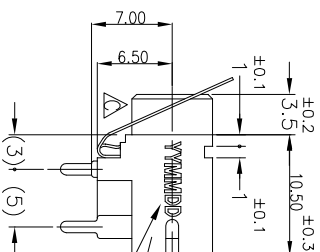
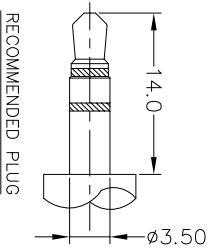
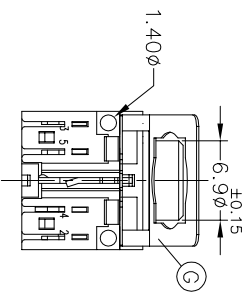
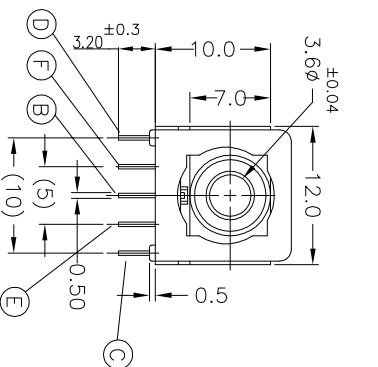
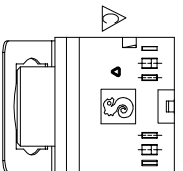
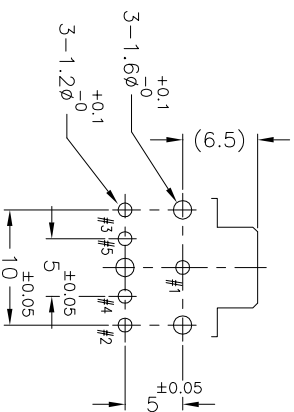


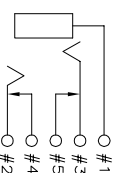
REV.	E/CN NO. OR DESCRIPTION	REVISED	DATE
A	E/CN NO.: C202210-007 產品變更 詳細尺寸 P510-00X -> ZSJ-P510-004	Zwei-Wu	2023.01.06



DATE CODE (A)



PCB LAYOUT



CIRCUIT:

- NOTES:
1. SPECIFICATION SEE 2.5&3.50 PHONE JACK PRODUCT SPECIFICATION
 2. TO CONFORM TO THE "SE-01-001" & "ROHS DIRECTIVE"
 3. GREEN PRODUCT IDENTIFICATION MARK IN JACK:
 4. GREEN PRODUCT IDENTIFICATION LABEL IN PACKING:
 5. FOR LEAD-FREE PROCESS.
 6. SOLDER HEAT RESISTANCE: WAVE SOLDER CONDITION 260°C 10 SECS.

G.P. PASS

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
A	BODY	1	PBT UL 94V-0	LIME COLOR(577C)
B	EARTH TERMINAL	1	BRASS 0.5t	SILVER PLATING
C	TIP SPRING	1	COPPER ALLOY 0.3t	SILVER PLATING
D	RING SPRING	1	COPPER ALLOY 0.25t	SILVER PLATING
E	SHUNT TERMINA-A	1	BRASS 0.4t	SILVER PLATING
F	SHUNT TERMINA-B	1	BRASS 0.4t	SILVER PLATING
G	GROUNDING SPRING	1	STAINLESS STEEL 0.2t	

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X : ±0.5 X : ±2°	X : ±2°
XX : ±0.3 XX : ±1°	
XXX : ±0.2	

TITLE	3.50 PHONE JACK
DWN	Zwei-Wu PART NO: ZSJ-P510-004
CHKD	Qicai-Hu SCALE 5:1 UNIT: mm
APVD	Jim-deng SIZE: A3 SHEET: 10F1 REV: A

CUSTOMER COPY

Singatron Enterprise Co., Ltd.
信亨企業股份有限公司